To ICDCM 2019 committee

E-mail：[icdcm2019-exhi@aitech.ac.jp](mailto:icdcm2019-exhi@aitech.ac.jp)

# **The 3rd IEEE International Conference on DC Microgrids**

# **Exhibition Application form**

In accordance with "Exhibition Information", we will apply as follows.

|  |  |  |  |
| --- | --- | --- | --- |
| Application Date | |  | |
| Corporation | Name |  | |
| URL |  | |
| Address |  | |
| Contact Person | Name |  | |
| Division |  | |
| TEL |  | |
| FAX |  | |
| E-mail |  | |
| Number of booths applied | |  | (JPY50,000 per booth) |
| Exhibit Contents | |  | |
| Remarks | |  | |

※Personal information you fill in will be used only for business related to ICDCM2019.

※After receipt of application, we will send an invoice for exhibition fee from the committee.